

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Shunpei Yamazaki	02/04/2004
Toru Takayama	02/05/2004
Junya Maruyama	02/05/2004
Yuugo Goto	02/05/2004
Yumiko Ohno	02/05/2004
Yasuyuki Arai	02/06/2004
Noriko Shibata	01/31/2004
RECEIVING PARTY DATA	
Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13775526
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NAME OF SUBMITTER:	APRIL K. SAUNDERS-FULLER
SIGNATURE:	/April K. Saunders-Fuller/
DATE SIGNED:	03/31/2014

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Total Attachments: 1

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ASSIGNMENT

For valuable consideration, We, Shunpei YAMAZAKI of Setagaya, Tokyo, Japan, Toru TAKAYAMA of Atsugi, Kanagawa, Japan, Junya MARUYAMA of Ebina, Kanagawa, Japan, Yuugo GOTO, Atsugi, Kanagawa, Japan, Yumiko OHNO of Atsugi, Kanagawa, Japan, Yasuyuki ARAI of Atsugi, Kanagawa, Japan and Noriko SHIBATA of Atsugi, Kanagawa, Japan hereby assign to Semiconductor Energy Laboratory Co., Ltd., a Japanese corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE filed 2/25/13, and assigned U.S. Serial Number 13775526, and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Signature: Shunpei Yamazaki
Name: Shunpei YAMAZAKI
Date: 02/04/2004

Signature: Yumiko Ohno
Name: Yumiko OHNO
Date: 02/05/2004

Signature: Toru Takayama
Name: Toru TAKAYAMA
Date: 02/05/2004

Signature: Yasuyuki Arai
Name: Yasuyuki ARAI
Date: 02/06/2004

Signature: Junya Maruyama
Name: Junya MARUYAMA
Date: 02/05/2004

Signature: Noriko Shibata
Name: Noriko SHIBATA
Date: 01/31/2004

Signature: Yuugo Goto
Name: Yuugo GOTO
Date: 02/05/2004